

**isc N-Channel MOSFET Transistor**

**BUZ10**

**DESCRIPTION**

- Typical  $R_{DS(on)} = 0.06 \Omega$
- High current capability
- 175°C operating temperature

**APPLICATIONS**

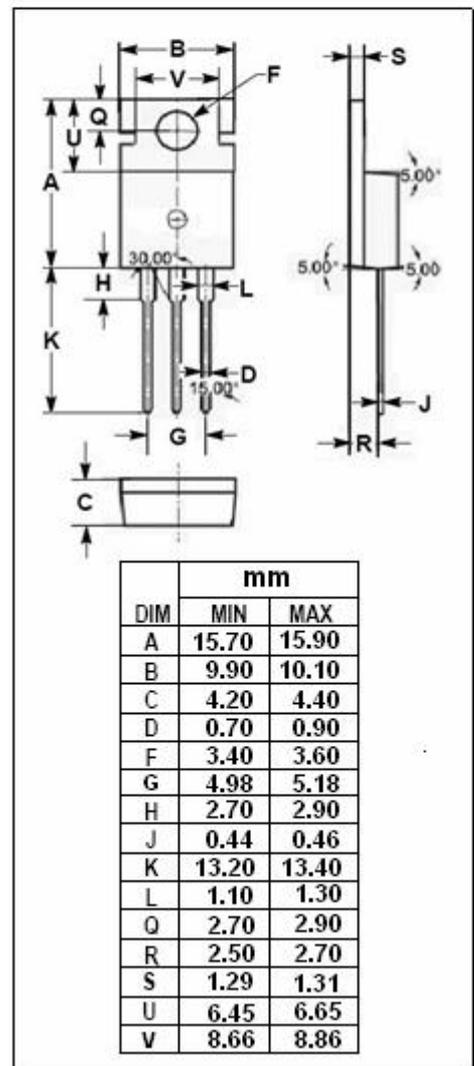
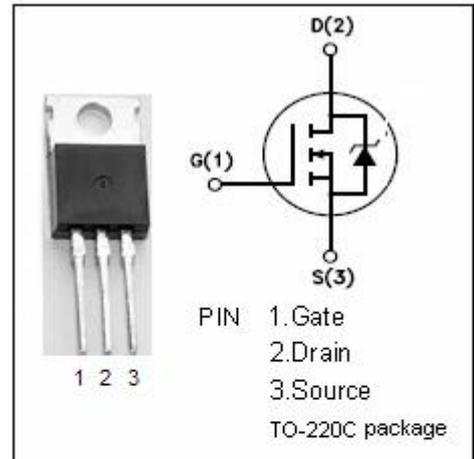
- High current , high speed switching
- Solenoid and relay drivers
- DC-DC & DC-AC converters

**ABSOLUTE MAXIMUM RATINGS(T<sub>a</sub>=25°C)**

SYMBOL	ARAMETER	VALUE	UNIT
V <sub>DSS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0)	50	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current-continuous@ TC=37°C	23	A
P <sub>tot</sub>	Total Dissipation@TC=25°C	75	W
T <sub>j</sub>	Max. Operating Junction Temperature	175	°C
T <sub>stg</sub>	Storage Temperature Range	-65~175	°C

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	MAX	UNIT
R <sub>th j-c</sub>	Thermal Resistance,Junction to Case	2.0	°C/W
R <sub>th j-a</sub>	Thermal Resistance,Junction to Ambient	62.5	°C/W



**isc N-Channel Mosfet Transistor****BUZ10****• ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C)**

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0; I <sub>D</sub> = 0.25mA	50		V
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> ; I <sub>D</sub> = 1mA	2.1	4	V
R <sub>DS(ON)</sub>	Drain-Source On-stage Resistance	V <sub>GS</sub> = 10V; I <sub>D</sub> = 14A		0.07	Ω
I <sub>GSS</sub>	Gate Source Leakage Current	V <sub>GS</sub> = ±20V; V <sub>DS</sub> = 0		±100	nA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 50V; V <sub>GS</sub> = 0		1	uA
V <sub>SD</sub>	Diode Forward Voltage	I <sub>F</sub> = 46A; V <sub>GS</sub> = 0		1.9	V